

LIGHT



Features

- Pb free product RoHS compliant
- Low power consumption, High efficiency
- General purpose leads
- Reliable and rugged
- Long life

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Electrical Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Тур.	. Max. Unit		Test Condition
Radiant Intensity	Ie	10.5	14.0	18.5	mW/sr	I _F =50mA (Note 1,3)
Viewing Angle						

LIGHT



Infrared Emitting Diode Specification

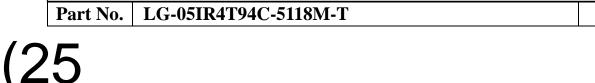
•Commodity: Infrared emitting diode

●Intensity Bin Limits (At 50mA)

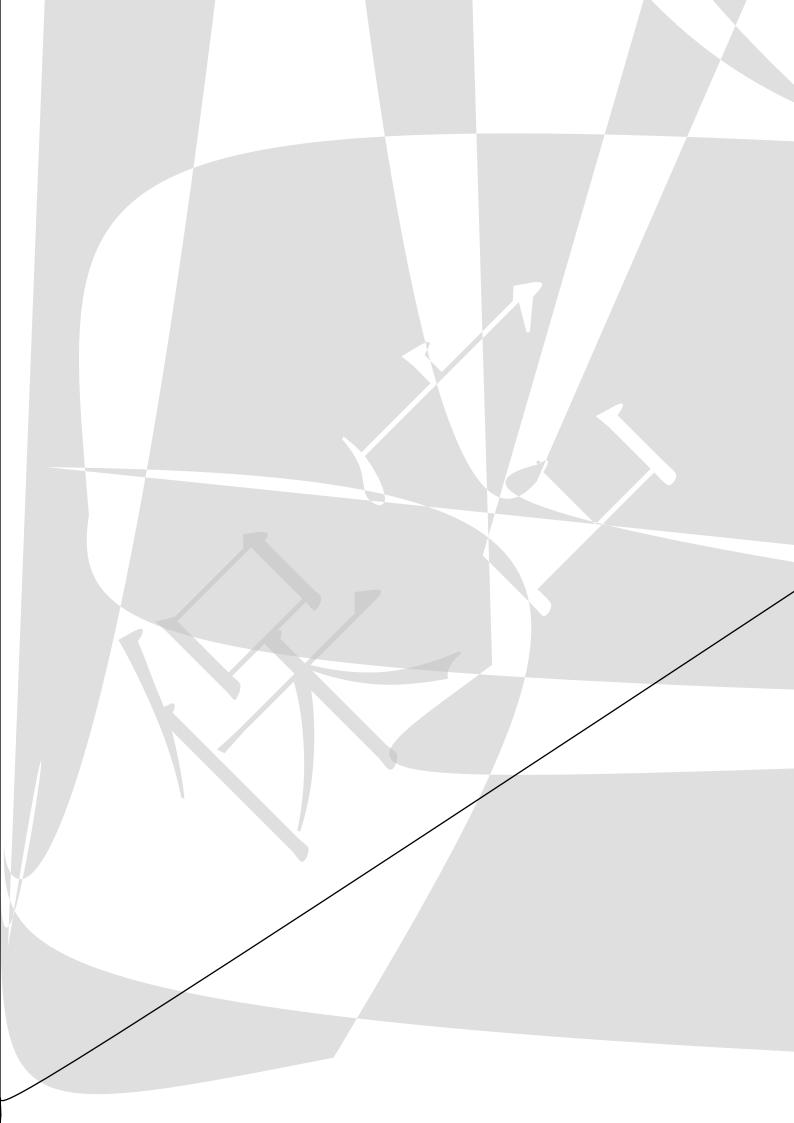
BIN CODE	Min.(mW/sr)	Max.(mW/sr)
27	10.5	14.0
28	14.0	18.5

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LEAD FORMING PROCEDURES

1. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend (Fig.5 and Fig.6).

2. <u>Lead for generating must be performed before soldering</u>, never during or aftersoldering.

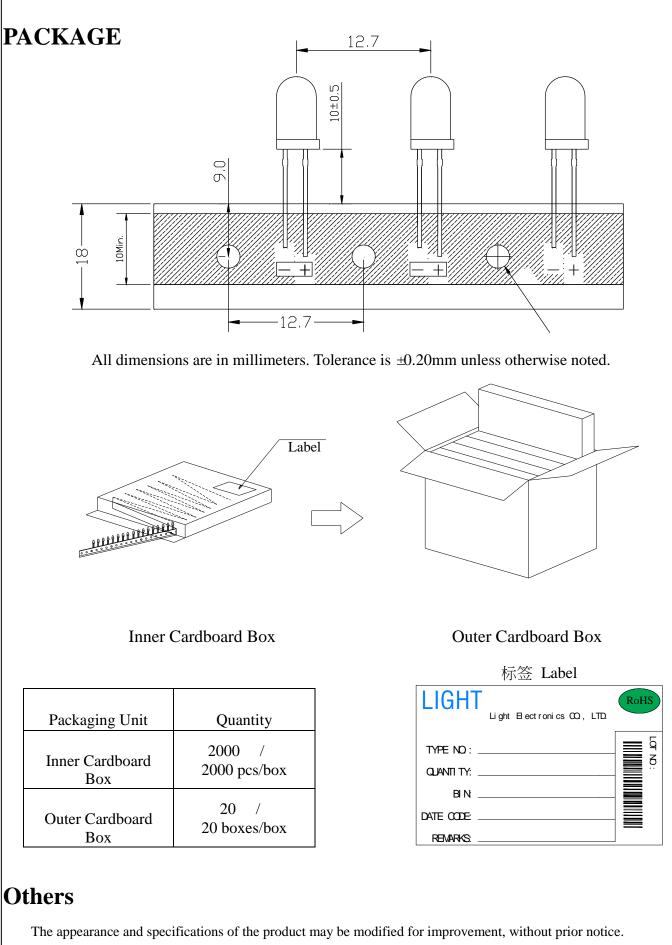
3. Do not stress the LED lens during lead-forming in order to fractures in the lens epoxy and damage the internal structures.

4. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead

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